

**Product Texts**

**Platamid® H 005 Pellets**

Copolyamide Hot Melt Adhesive / Extrusion Applications

**Platamid® H 005** is a standard thermoplastic co-polyamide hot melt adhesive available in pellet form. This medium melt viscosity grade is particularly suitable for manufacturing webs, nets, mono- and multi-filaments, and films by extrusion.

**Platamid® H 005** offers a very good adhesion to various polar substrates (thermoplastics, thermosets, metal, natural fibers, etc).

**Platamid® H 005** has a very good dry cleaning resistance and washing resistance up to 60°C.

**AVAILABLE GRADES**

This product is available:

- Dried (H 005 T)
- Dried with optical brightener (H 005 TA)
- Un-dried with optical brightener (H 005 FA)

**PACKAGING**

- Platamid® H 005 T is delivered in 25 kg sealed bags.
  - Platamid® H 005 TA is delivered in 25 kg sealed bags and 500 kg sealed big bags (GRVS).
  - Platamid® H 005 FA is delivered in 500 kg big bags (GRVS or GRVS ALU).
- These grades are ready to be processed.

**SHELF LIFE**

Two years from the date of delivery. For any use above this limit, please refer to our technical services.

Processing/Physical Characteristics	dry / cond	Unit	Test Standard
<b>ISO Data</b>			
<sup>[C]</sup> Melt volume-flow rate, MVR	10 / *	cm <sup>3</sup> /10min	ISO 1133
Temperature	160 / *	°C	-
Load	2.16 / *	kg	-

[C]: CAMPUS

Thermal properties	dry / cond	Unit	Test Standard
<b>ISO Data</b>			
<sup>[C]</sup> Melting temperature, 10°C/min	115 / *	°C	ISO 11357-1/-3

[C]: CAMPUS

Other properties	dry / cond	Unit	Test Standard
<sup>[C]</sup> Density	1070 / -	kg/m <sup>3</sup>	ISO 1183

[C]: CAMPUS

**Characteristics**

**Processing**

Film Extrusion

**Delivery form**

Pellets

**Features**

Good Adhesion, Copolymer

**Applications**

Monofilament, Multifilament

**Regional Availability**

North America, Europe, Asia Pacific, South and Central America, Near East/Africa